

Custom Integrable Detector Module

Features

- ✓ Fast and highly portable spectrometer
- ✓ Option for ≤0.8% FWHM energy resolution at 662 keV and interaction-by-interaction resolution of ≤0.65% FWHM
- ✓ Ready to use in less than 60 s
- √ Rapidly identifies gamma-ray sources
- ✓ Industry-leading efficiency with up to >29 cm³ pixelated CZT
- ✓ Real-time spectroscopy and ID
- ✓ Discrimination between background and sources of interest in less than 20 s
- ✓ Single USB connection for power and control
- ✓ Wireless, Ethernet, or USB communication
- ✓ Option for gamma-ray imaging from 250 keV to 3 MeV
- ✓ Option to synchronize data collection with other radiation detectors for coincidence detection



The M400 system mounted on a drone.

Integrate H3D's detector module into your product. This box contains everything you need for high-resolution spectroscopy.

Perfect for integration with:

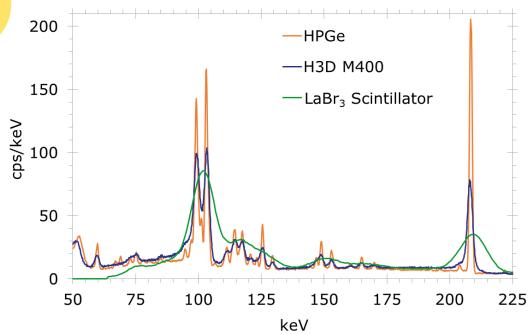
- □ Drones
- Robots
- ☐ Laboratory experiments
- Medicalimaging arrays
- Other sensor suites



Containing the most advanced room-temperature semiconductor technology to achieve spectroscopic performance competitive with cryogenically cooled detectors, the detector module has:

- ☐ Compact and light-weight size
- □ Fast startup
- Excellent energy resolution
- Low power

Contact H3D to create a custom solution for your application.



Any options can be combined, except as noted.

High-Resolution Option (M400+)

Improve energy resolution to ≤0.8% FWHM at 662 keV (coincident interactions combined) and ≤0.65% FWHM at 662 keV (coincident interactions separated)

Lower Efficiency Options

M200

Crystal Volume: >9.5 cm³
Anode Pixelation: 2 x 11 x 11
Sensitivity: Detect in <44 s

M100

Crystal Volume: $>4.5 \text{ cm}^3$ Anode Pixelation: $1 \times 11 \times 11$ Sensitivity: Detect in <88 s

Extra-High-Efficiency Option (M400-15)

Increase crystal volume to >29 cm³. Also available as a higher-resolution M400+-15 with no resolution guarantee.

M400 Base Specifications

Note: Custom designs also available

Dimensions: 4.0 in x 2.25 in x 2.25 in (10.2 cm x 5.7 cm x 5.7 cm)

Weight: 1.3 lbs (0.6 kg)
Battery: Optional add-on box

Power Input: 5 V, <6 W, USB-C (option for other connectors) Startup & Operating Temp.: -20° C to 50° C (-4° F to 122° F) with fan enabled

-10° C to 35° C (14° F to 95° F) with fan disabled

Startup Time: <60 s

Energy Resolution

at 25° C (77° F): ≤1.1% FWHM at 662 keV (coincident interactions combined)

≤0.9% FWHM at 662 keV (coincident interactions separated)

Sensitivity: Detects 10- μ Ci ¹³⁷Cs at 1 m (~3 μ R/hr) in < 22 s

(in natural background)

Spectroscopy Range: 50 keV to 3 MeV

Crystal Volume: >19 cm³ CZT (CdZnTe)

Anode Pixelation: 4 x 11 x 11

Spatial Resolution: <0.5 mm (≥140 keV)

Count-Rate Limit: 1 rem/hr (10 mSv/hr) bare-¹³⁷Cs equivalent
Maximum Event Rate: 75 kcps at <0.5-mm spatial resolution
150 kcps at <2-mm spatial resolution

Coincidence: FPGA-level architecture

Communication Options: USB to computer USB to Ethernet

Wireless communication interfaces available

Data API Options: Real-time spectrum

Event total energy, each interaction energy, and time stamp

Compton Imaging Option (M400i)

Image Energy Range: 250 keV to 3 MeV

Field of View: 4n (360°) omnidirectional

Angular Precision: ±1° source localization for all 4π (real time)
Angular Resolution: ~30° FWHM for all 4π (real time; >250 keV)

~20° FWHM for all 4п (post processing; >250 keV)

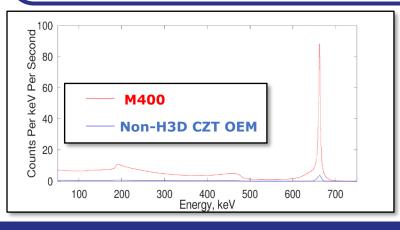
Sensitivity: Localize point source of 137 Cs producing $\sim 3 \,\mu$ R/hr in $< 90 \, s$

Data API Options: Each interaction 3D position (x, y, z)

Optical Camera and Imaging Option (M400iC)

All specifications of M400i, and...

Optical Field of View: >162° horizontal, >122° vertical; full color ± 2 ° to radiation image in front 90° \times 90°



Spectral comparison between H3D M400 and non-H3D CZT OEM. (10 µCi 137Cs, 5 cm)



CE





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